

Small switching (600V, 2A)

2SK3050

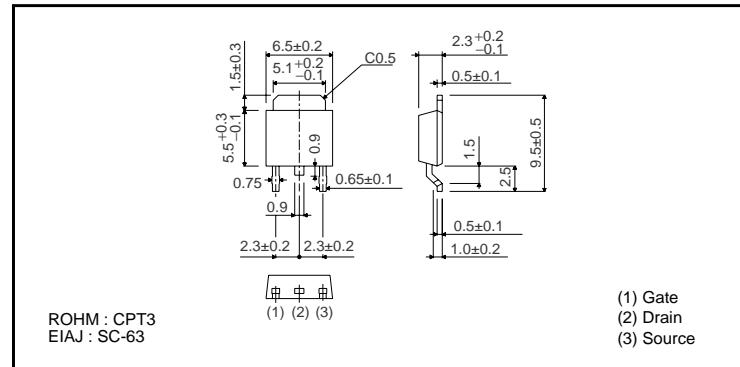
●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) Gate-source voltage (V_{GS}) guaranteed to be $\pm 30V$.
- 5) Easily designed drive circuits.
- 6) Easy to use in parallel.

●Structure

Silicon N-channel
MOSFET

●External dimensions (Unit : mm)



●Absolute maximum ratings ($T_a=25^\circ C$)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V_{DS}	600	V	
Gate-source voltage	V_{GS}	± 30	V	
Drain current	Continuous	I_D	2	A
	Pulsed	I_{DP}^*	6	A
Reverse drain current	Continuous	I_{DR}	2	A
	Pulsed	I_{DRP}^*	6	A
Total power dissipation ($T_c=25^\circ C$)	P_D	20	W	
Channel temperature	T_{ch}	150	$^\circ C$	
Storage temperature	T_{stg}	-55 to +150	$^\circ C$	

* $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

●Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	2500
2SK3050		○

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●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Gate-source leakage	I_{GSS}	-	-	±100	nA	$V_{GS}=\pm 30V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	600	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	-	-	100	μA	$V_{DS}=600V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	2.0	-	4.0	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)}$	-	4.4	5.5	Ω	$I_D=1A, V_{GS}=10V$
Forward transfer admittance	$ Y_{fs} $	0.5	1.0	-	S	$I_D=1A, V_{DS}=10V$
Input capacitance	C_{iss}	-	280	-	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	-	48	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	-	16	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}$	-	12	-	ns	$I_D=1A, V_{DD}=300V$
Rise time	t_r	-	17	-	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}$	-	29	-	ns	$R_L=300\Omega$
Fall time	t_f	-	105	-	ns	$R_G=10\Omega$
Reverse recovery time	t_{rr}	-	460	-	ns	$I_{DR}=2A, V_{GS}=0V$
Reverse recovery charge	Q_{rr}	-	2.0	-	μC	$di/dt=100A/\mu s$

●Electrical characteristic curves

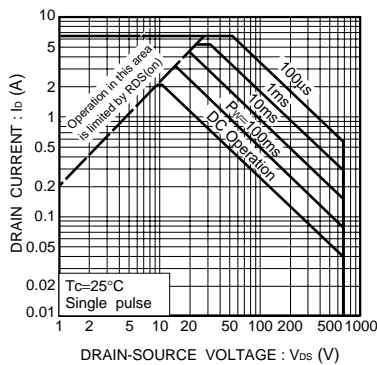


Fig.1 Maximum safe operating area

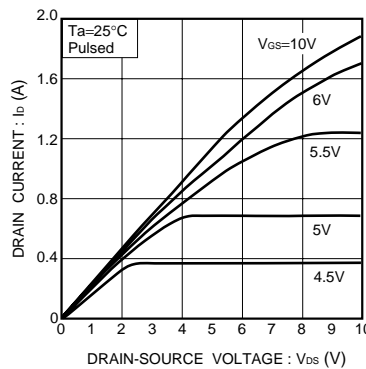


Fig.2 Typical output characteristics

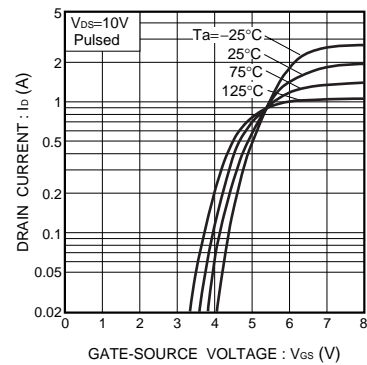


Fig.3 Typical transfer characteristics

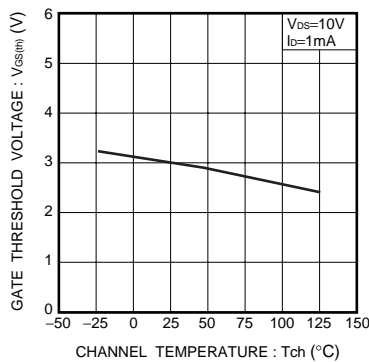


Fig.4 Gate threshold voltage vs. channel temperature

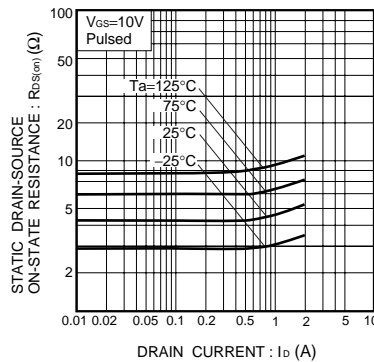


Fig.5 Static drain-source on-state resistance vs. drain current

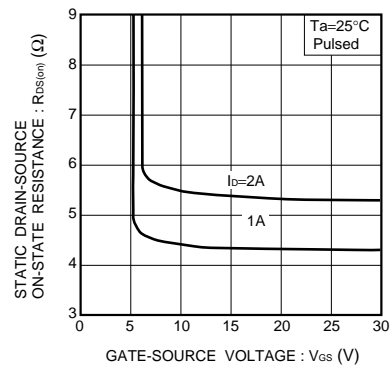


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

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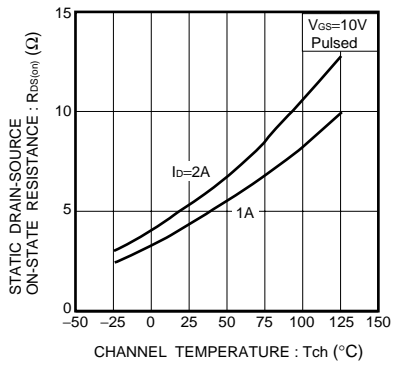


Fig.7 Static drain-source on-state resistance vs. channel temperature

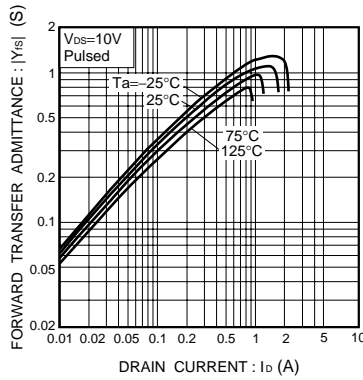


Fig.8 Forward transfer admittance vs. drain current

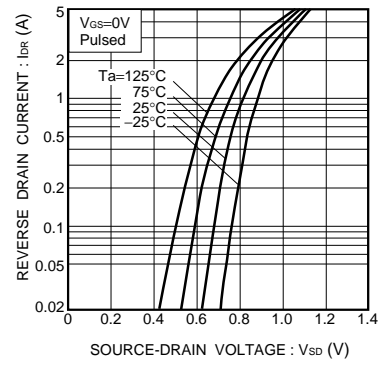


Fig.9 Reverse drain current vs. source-drain voltage (I)

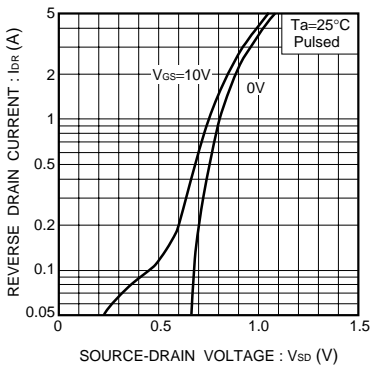


Fig.10 Reverse drain current vs. source-drain voltage (II)

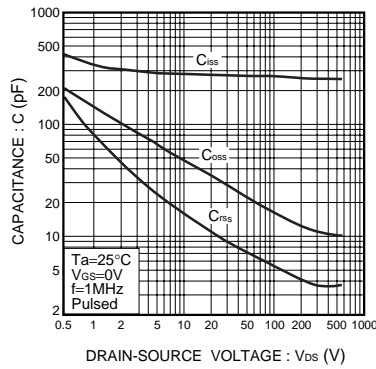


Fig.11 Typical capacitance vs. drain-source voltage

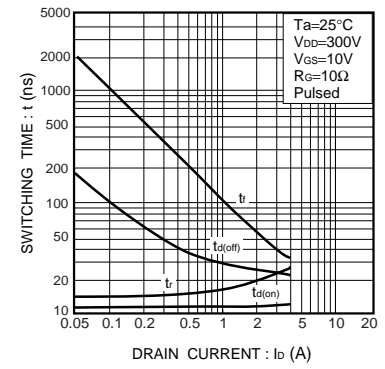


Fig.12 Switching characteristics

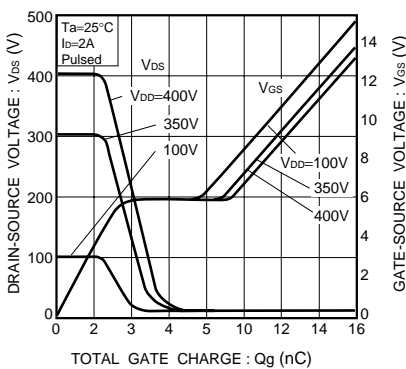


Fig.13 Dynamic input characteristics

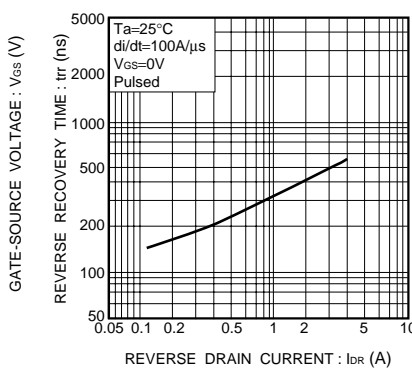


Fig.14 Reverse recovery time vs. reverse drain current

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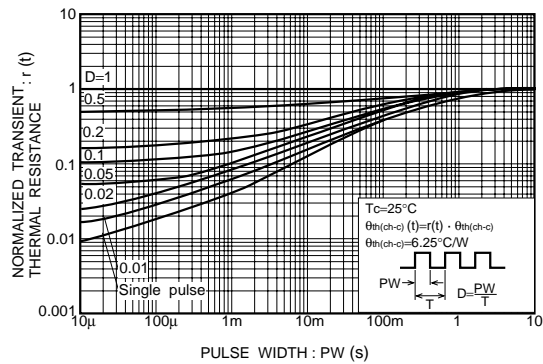


Fig.15 Normalized transient thermal resistance vs. pulse width

●Switching characteristics measurement circuit

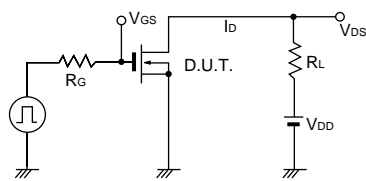


Fig.16 Switching time measurement circuit

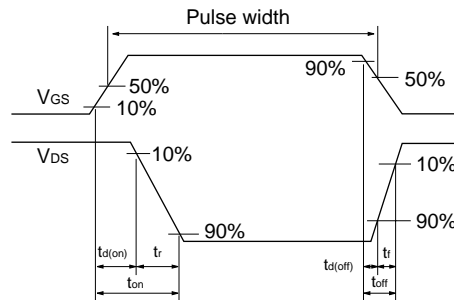


Fig.17 Switching time waveforms

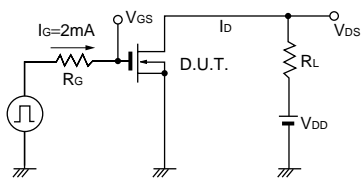


Fig.18 Gate charge measurement circuit

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